

) Attorney Docket No.: DOCKET 00-282
) (6653)68510
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)
)
) First Named Inventor: Chok J. Chia
)
) Application Number: TBD
)
) Filing Date: Herewith
)
) Group Art Unit: not yet known
)
) Examiner Name: not yet known

My residence, post office address and citizenship are as stated below next to my name.

I believe I am the original, first and sole inventor (if only one name is listed below) or an original, first and joint inventor (if plural names are listed below) of the subject matter which is claimed and for which a patent is sought on the invention entitled:

INSULATED BONDING WIRE FOR MICROELECTRONIC PACKAGING

[X] is attached hereto, or

[] was filed by an authorized person on my behalf on _____ as United States Application Number _____ (Date) or PCT International Application Number _____ and was amended on _____ (if applicable). (Date)

I acknowledge the duty to disclose information which is material to patentability as defined in Title 37, Code of Federal Regulations, §1.56.

Declaration 1-1297

which designated at least one country other than the United States of America, listed below, and I have also identified below, by checking the box, any foreign application for patent or inventor's certificate, or any PCT international application, on this invention filed by me or my legal representatives or assigns and having a filing date before that of the application on which priority is claimed:

Prior Foreign Application Number(s)	Country	Foreign Filing Date	Priority Not Claimed	Certified Copy Attached	
				Yes	No

N/A

[]Additional foreign application numbers are listed on a supplemental priority data sheet attached hereto.

I hereby claim the benefit under Title 35, United States Code, §119(e) of any United States provisional application(s) listed below:

Provisional Application Number(s)	Provisional Application Filing Date
--------------------------------------	--

N/A

[]Additional provisional application numbers are listed on a supplemental priority data sheet attached hereto.

I hereby claim the benefit under Title 35, United States Code, §120, of any prior United States application(s), or under §365(c) of any PCT international application(s) designating the United States of America, listed below and, insofar as the subject matter of each of the claims of this application is not disclosed in the prior United States or PCT international application(s) in the manner provided by the first paragraph of Title 35, United States Code, §112, I acknowledge the duty to disclose all information known by me to be material to patentability as defined in Title 37, Code of Federal Regulations, §1.56, which became available between the filing date of the prior application(s) and the national or PCT international filing date of this application:

Prior U.S. Application Number	Prior PCT International Application Number	Filing Date of U.S. or PCT International Application	Patent Number (if applicable)
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N/A

[]Additional U.S. or PCT international application numbers are listed on a supplemental priority data sheet attached hereto.

As a named inventor, I hereby appoint the following registered practitioners, with full power of substitution and revocation, to prosecute

this application and to transact all business in the United States Patent and Trademark Office connected therewith, and request that all correspondence and telephone calls in respect to this application be directed to:

LSI Logic Corporation
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Intellectual Property Services Group
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and I hereby further appoint:

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and I hereby further appoint:

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Julius Tabin	16,754	Philip T. Petti	31,651
John F. Flannery	19,759	Bruce R. Mansfield	29,086
Robert B. Jones	20,135	Richard A. Kaba	30,562
James J. Schumann	20,856	Karl R. Fink	34,161
James J. Hamill	19,958	Thomas F. Lebens	38,221
Timothy E. Levstik	30,192	Richard E. Wawrzyniak	36,048
Joseph E. Shipley	31,137	Scott J. Menghini	42,880

I hereby declare that all statements made herein of my own knowledge are true, and that all statements made herein on information and belief are believed to be true; and further that these statements were made with the knowledge that willful false statements and the like so made are punishable by fine or imprisonment, or both, under Section 1001 of Title 18 of the United States Code, and that such willful false statements may jeopardize the validity or enforceability of the application or any patent issued thereon.

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